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AN 105:180503 HCA Manufacture of high-purity electrolytic copper TI IN Takewaki, Masahiro; Sumya, Hiroki; Manabe, Yoshiaki PA Sumitomo Metal Mining Co., Ltd., Japan SO Jpn. Kokai Tokkyo Koho, 3 pp. CODEN: JKXXAF $\overline{\mathbf{DT}}$ Patent Japanese FAN.CNT 1 PATENT NO. KIND DATE APPLICATION NO. DATE ---------ΡI JP 61084389 A2 19860428 JP 1984-204346 19840928 AB A high-purity Cu sulfate bath contg. 90-220 g/L free SO42- is electrolyzed, using an electrolytic Cu anode, at a cathode c.d. of .ltoreq.2.5 A/dm2 and .ltoreq.40.degree. to give an electrolytic cathode Cu of purity .gtoreq.99 .999 wt.%. The refined Cu has excellent elongation properties and is useful as bonding for semiconductor devices, wires for motors, etc. Thus, a bath contg. Cu 42 and SO42- 93 g/L was electrolyzed at 25.degree. and at a cathode c.d. of 1.5 A/dm2, using a Ti cathode and an electrolytic Cu anode (purity 99.99 wt.%) which was placed in a Tetron 501 B box to deposit high-

purity Cu contg. S <1, Ag <1, Fe <0.6, and Si</pre>

<1 ppm on the cathode.